



BLE debugging terminal
P2.1 (SWIVEL): DD port on SAT0016
P2.2 (PAIR_SW): DC port on SAT0016

BLE Debugging Terminal J1:
P2.1 (DD) - SWIVEL
P2.2 (DC) - PAIR_SW
RESET_N - RST_SW

Debugger can power CC2541 directly by populating R14 with 0 ohm resistor.

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Number: TIDA-00356	Rev: E.1.1	Designed for: Public Release	Mod. Date: 12/10/2014
SVN Rev: Version control disabled	Assembly Variant: 001	Project Title: Automotive Wireless External Control - Switch Modu	Sheet Title: CC2541 BLE Module
Drawn By: Engineer	Engineer: Engineer	File: Control_SchDoc	Size: B
		Sheet: 3 of 4	http://www.ti.com
		Contact: http://www.ti.com/support	© Texas Instruments 2014



~~DNP~~
FID1

~~DNP~~
FID2

~~DNP~~
FID3

~~DNP~~
FID4

~~DNP~~
FID5

~~DNP~~
FID6

PCB Number: TIDA-00356
PCB Rev: E1.1

Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

~~ZZ2~~
~~DNP~~
These assemblies are ESD sensitive, ESD precautions shall be observed.

~~ZZ3~~
~~DNP~~
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

~~ZZ4~~
~~DNP~~
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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